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NOTES:

- THIS IS A 4 LAYER BOARD WITH COMPONENTS ON BOTH SIDES.
- PRINTED CIRCUIT BOARD SHALL BE 2 OUNCE COPPER.
BOARD MATERIAL TO BE EXPOXY BASED FR-4.
- SMOBC SOLDERMASK BOTH SIDES USING RED RESIST. IAW IPC-SM-840
- SILKSCREEN BOTH SIDE(S) USING WHITE NON CONDUCTIVE EPOXY BASED INK. TRIM ALL SILKSCREEN 4mils FROM BARE COPPER
- MANUFACTURE/FABRICATE TO MEET EU RoHS DIRECTIVE.
ALL MATERIALS AND SOLDERMASK TO BE COMPLIANT TO EU RoHS DIRECTIVE 20002/95/EC
LAMINATE AND RESIN MATERIAL PARAMETERS
T_g > 170 C
T_d > 294 C
- ELECTROLESS NICKEL GOLD OR IMMERSION GOLD BOARD FINISH.
- MINIMUM TRACE WIDTH 8 MILS/ SPACE 6 MILS

DRILL CHART: TOP to BOTTOM			
ALL UNITS ARE IN MILS			
FIGURE	SIZE	PLATED	QTY
•	10.0	PLATED	776
•	28.0	PLATED	5
•	37.0	PLATED	14
•	40.0	PLATED	61
▲	41.0	PLATED	11
•	65.0	PLATED	2
•	93.0	PLATED	2
•	100.0	PLATED	3
•	255.0	PLATED	6
•	128.0	NON-PLATED	4
-	76.0x28.0	PLATED	2

Drawn By: MARGARET SAVIED	Date Drawn: 06/06/18	Engineer: Ashwini Ravindran
Released By:	Date Released:	ISL9241EVALIZ Fabrication Drawing
Updated By:	Date Updated:	
A Hanesco Company	FILENAME: ISL9241EVALIZ_E	SHEET 1 of 1